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n re application of: Rich Fogal Tracy Reynolds Timothy Cowles

Serial No.: 09/945,084

Filed: August 30, 2001

For: METHOD AND APPARATUS FOR CIRCUIT COMPLETION THROUGH THE USE OF BALL BONDS OR OTHER CONNECTIONS DURING THE FORMATION OF A SEMICONDUCTOR

DEVICE

Group Art Unit: 2823

§ Examiner: Khiem D. Nguyen

Docket No.: 2001-0128.00

Confirmation No.: 3141

Mail Stop Issue Fee Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Certificate of Mailing (37 CFR §1.8)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, VA 22313-1450, on the date below:

November 7, 2005 Date Merry Helmy Signature

COMMENTS ON STATEMENT OF REASONS FOR ALLOWANCE

Applicant submits that each one of the claims of the captioned application is allowable over the cited art for reason of the cited art failing to disclose or suggest the features and/or combination of features as are defined therein. Although applicant acknowledges the Examiner's "Statement of Reasons for Allowance" as set forth with the Notice of Allowance mailed August 5, 2005, applicant submits that the reasons for allowance as provided by the Examiner may represent merely a portion of all of the reasons that support the patentability of the claims of the present application without necessarily being exhaustive.

If there are any matters which may be resolved or clarified through a telephone call, the Examiner is cordially invited to contact the undersigned.

Respectfully submitted,

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